IPC ASSOCIATION CONNECT ELECTRONICS INDUSTR	Material Compo © Copyright 2005. If international and Pan	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowe level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute					* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					als and Mf	fg Informat	ion	
upplier Infor	mation														
Company name*			Company unique ID			ī	Unique ID Authority					Response Date*			
nsemi											2025-06-02				
Contact Name		Title - Contact]	Phone - Contact*					Email - Contact*				
Product-Env-Stev	wards		Product Enviro Compliance				NA					Product-Env-Stewards@onsemi.com			
uthorized Repre	sentative*	Title - Representative			1	Phone - Representative*				Email - Representative*					
Product-Env-Stev	wards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
Reques	Requester Item Number Mf		Mfr Item Number Mfr Item Name				Effective Da	te Ver	rsion	Manufacturing Site		V	Weight*	UOM	Unit Type
		MURS36	60T3G	REC SMC 3A 600	REC SMC 3A 600V ULTFST TR		2025-06-02			VN5		2	250.86	mg	Each
Ianufacturing	g Proccess Informat	ion										·			·
Terminal Plating / Grid Array Material		Γerminal Base Alloy J-STD-020 MS		SL Rating	Peak Process Body Tempera		ture Max Time at Peak Temper		Temperatu	ure Numb	per of Reflow Cyc	eles			
Matte T	Γin (Sn) - annealed	C	CU Alloy	1			260		C	30		second	ds 3		
omments															
vel 1 - maximum	ı time at peak temperatu	re during sol	dering is 10-3	30 seconds											
or more informa	tion regarding material o	composition	please refer t	o page 3											

RoHS Material Composition Declaration			Declaration Type *	Detailed							
Directive 2015/863/EU amending RoHS Directive 2011/65/EU											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's St											
RoHS Declaration * 4 - Item(s	s) does not contain RoHS restricted substance	ces per the definition above except for selected exer	nptions Supplier Acceptance	* Accepted							
Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead). Exemption: 7c-I Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors, e.g. piezoelectronic devices, or in a glass or ceramic matrix compound.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.											
Supplier Digital Signature R		,									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Clip	39.16	mg	Supplier	Iron (Fe)	7439-89-6		0.0392	mg
			Supplier	Copper (Cu)	7440-50-8		39.1091	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0117	mg
Die	1.34	mg	Supplier	Silicon (Si)	7440-21-3		1.3266	mg
			Supplier	Lead Bisilicate	65997-18-4	7c	0.0134	mg
Die Attach Solder	2.82	mg	Supplier	Silver (Ag)	7440-22-4		0.0705	mg
			A	Lead (Pb)	7439-92-1	7a	2.6085	mg
			Supplier	Tin (Sn)	7440-31-5		0.141	mg
Lead Frame	74.95	mg	Supplier	Iron (Fe)	7439-89-6		0.075	mg
			Supplier	Copper (Cu)	7440-50-8		74.8526	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0225	mg
Mold Compound-Black	131.93	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		13.193	mg
			Supplier	Carbon Black (C)	1333-86-4		0.6596	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		19.1298	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		85.7545	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		13.193	mg
Plating	0.66	mg	Supplier	Tin (Sn)	7440-31-5		0.66	mg